

INFORMATION CITED BY APPLICANT THAT MAY BE MATERIAL TO THE
PROSECUTION OF THE SUBJECT APPLICATION

Applicant: Takayuki Haze Attorney Docket No. LEPA122745
Application No.: *(filed concurrently)* Group Art Unit:
Filed: April 13, 2004 Examiner:
Title: METHOD OF FORMING BUMP PAD OF FLIP CHIP AND STRUCTURE THEREOF

U.S. PATENT DOCUMENTS

*Examiner Cite Initials No.	Document No.	Kind Code	Date (mm/dd/yyyy)	Name
None				


FOREIGN PATENT DOCUMENTS

*Examiner Cite Initial No.	Document No.	Kind Code	Publication Date (mm/dd/yyyy)	Country	English Abstract Provided	Translation Provided
<u>REP</u> <u>REP</u> F1	1020030095574	A A	12/24/2003	Korea	X	
<u>REP</u> <u>REP</u> F2	1020030072855	A A	09/19/2003	Korea	X	
<u>REP</u> <u>REP</u> F3	1020030065924	A A	08/09/2003	Korea	X	
<u>REP</u> <u>REP</u> F4	1020030032465	A A	04/26/2003	Korea	X	

OTHER INFORMATION

(Including Author, Title, Date, Pertinent Pages, Etc.)

*Examiner Cite Initial No.
None

Examiner  Date Considered 3/19/00

*Examiner: Initial if reference considered, whether or not citation is in conformance with M.P.E.P. § 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

JEN:hjd